3GPP2 CORRESPONDENCE

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Dr. Ragnar Huslende
Chair, 3GPP CT3
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Re: LS Requesting 3GPP2 Assignment of a 3GPP2 Diameter AVP Corresponding to the 3GPP2 RADIUS VSA BSID

Dear Ragnar:

TSG-X thanks CT3 for the LS in C3-091144, requesting assignment of a 3GPP2 Diameter AVP named 3GPP2-BSID containing the same data as contained in the 3GPP2 RADIUS VSA BSID.

We are pleased to report that as requested TSG-X has defined a 3GPP2 Diameter AVP in our specification X.S0057-0 v2.0, and a file with details of the assignment is attached. Please note that this specification is still a work in progress and is not yet published.

Regards,

Betsy Covell

Betsy Covell
Chair, 3GPP2 TSG-X

Att: SF-xxxALT1-Starent-3GPP2 AVPs.doc

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